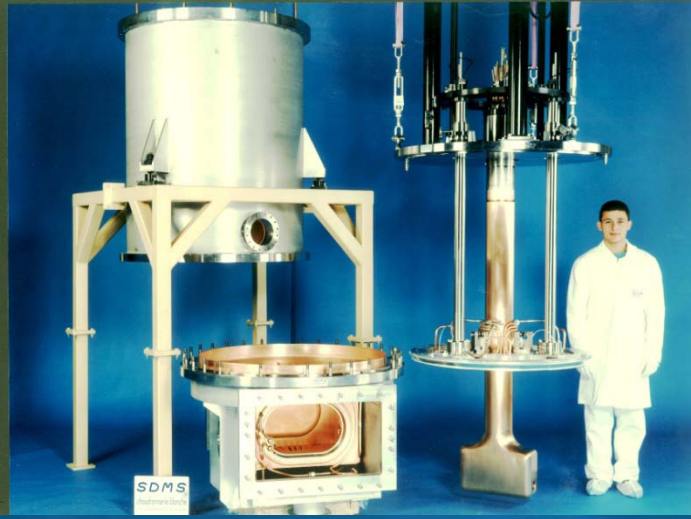


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RF Cavities Manufacturing Techniques I

CAS 2010 June 16, Ebeltoft Denmark

Pierre Maccioni, SDMS Technologies

38160 St Romans, France



- The main aims of this presentation are:
- To unveil and list the **under jacent basic and quite simple concepts** ruling the **NC RF Cavities** construction techniques
 - To show and describe now a days **Standard Technologies mastered by Industry** for manufacturing **NC RF Cavities**
 - To illustrate the talk with **several typical examples** based on **SDMS experience**

Who is SDMS Technologies ? A few numbers:

- 1 High Technology French SME Company

- For highly demanding customers... when Technology matters !

- 2 Plants locations:

- **St Romans:** 130 p. (30 engineers and managers) 20 M€/year
- **Manosque :** 90 p. (20 engineers and managers) 10 M€/year

- 3 Fields of Activities:

- Energy, Research, Defence&Space

- 4 Technologies Poles:

- Nuclear, Vacuum, Cryogenics, Mechatronics

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Cryogenics : 20%



Vacuum : 20%



Our Plant

St Romans



Nuclear : 60%



Our Clean



Workshops

NC RF Cavities made by Industry (Ideal Case)

1 - Design

2 – Materials

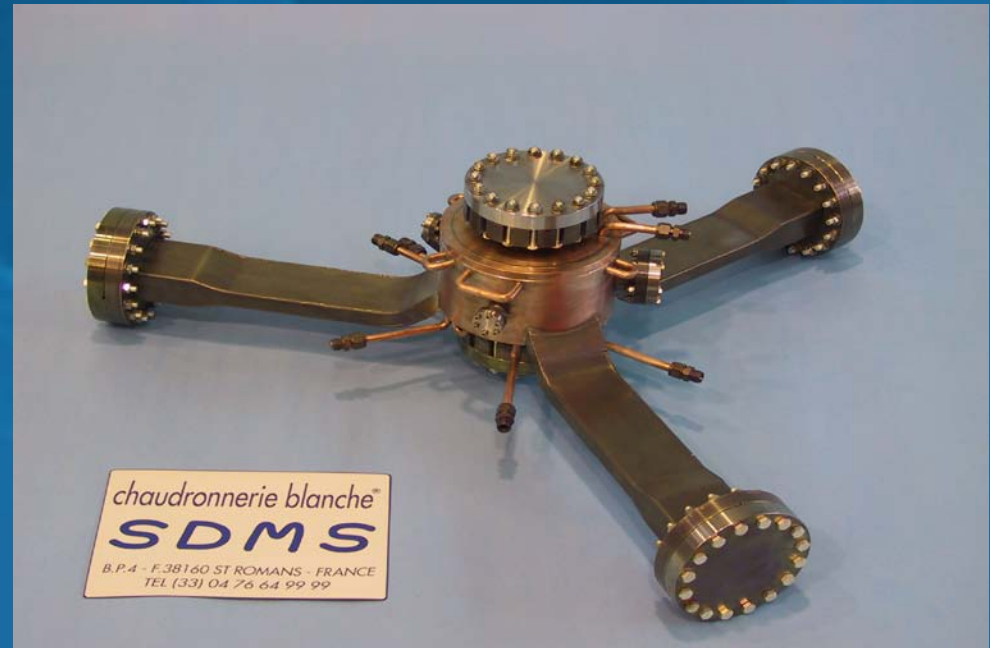
3 – Forming Techniques

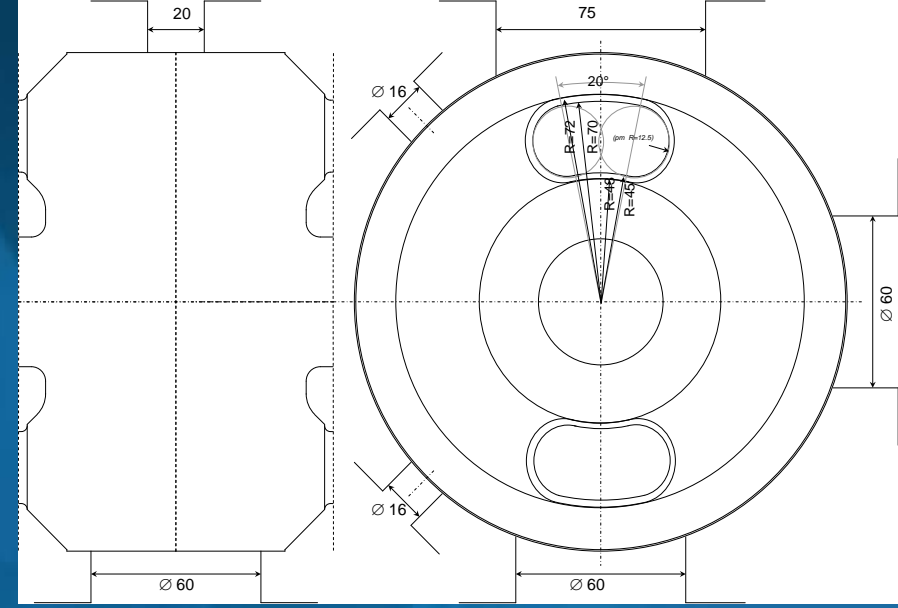
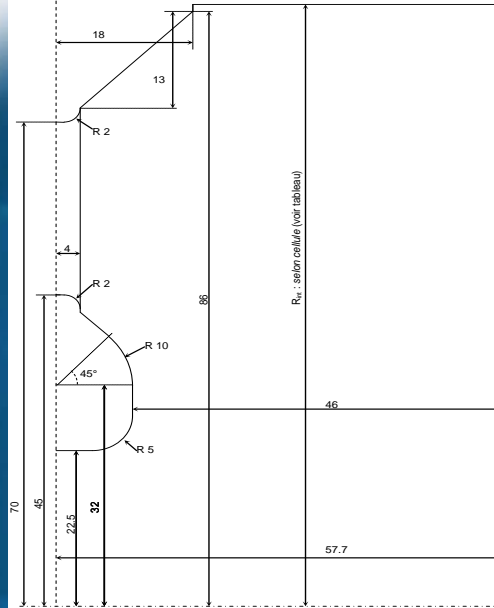
4 – Cleaning Techniques

5 – Joining Techniques

6 – ND Control Techniques, RF and Vacuum Conditioning

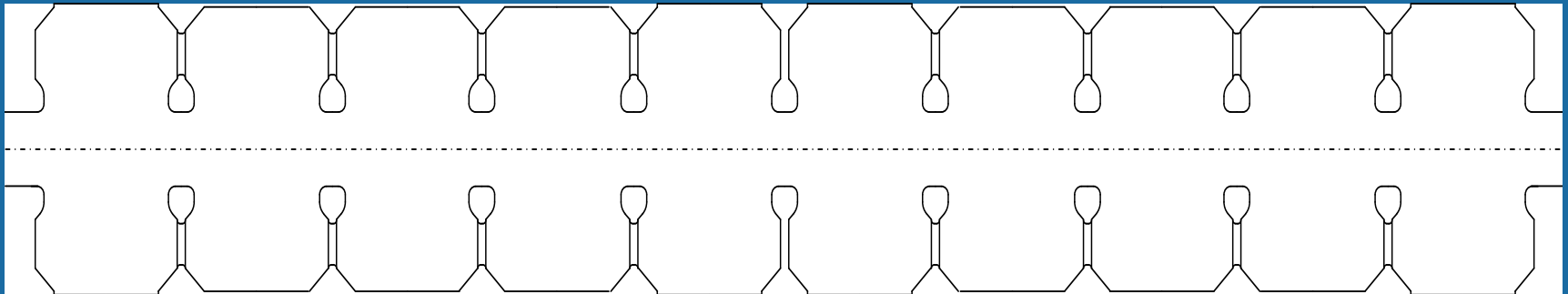
7 – New ESRF Cu Cavity: Comparison between 2 Manufacturing Routes

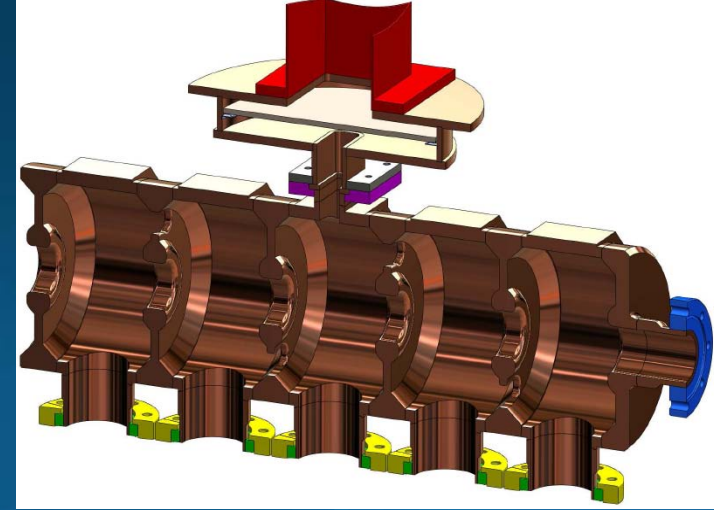
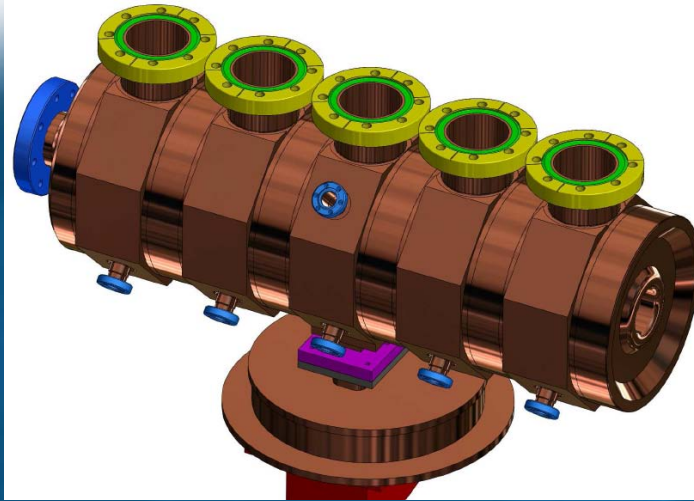




BASIC DESIGN (made by the Customer)

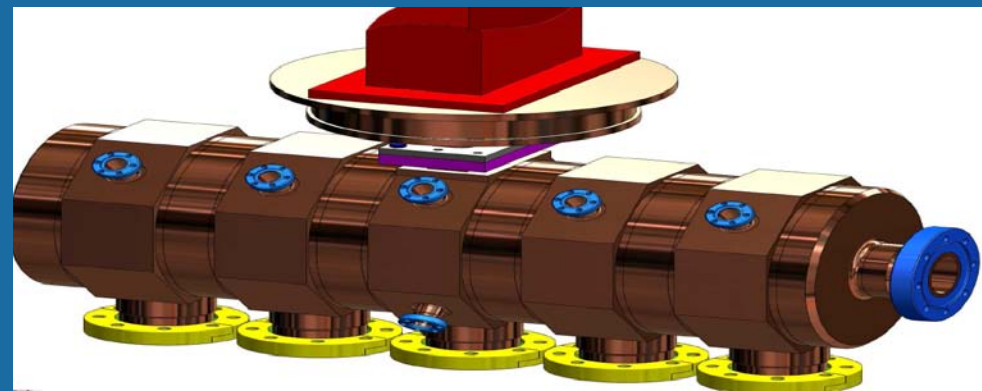
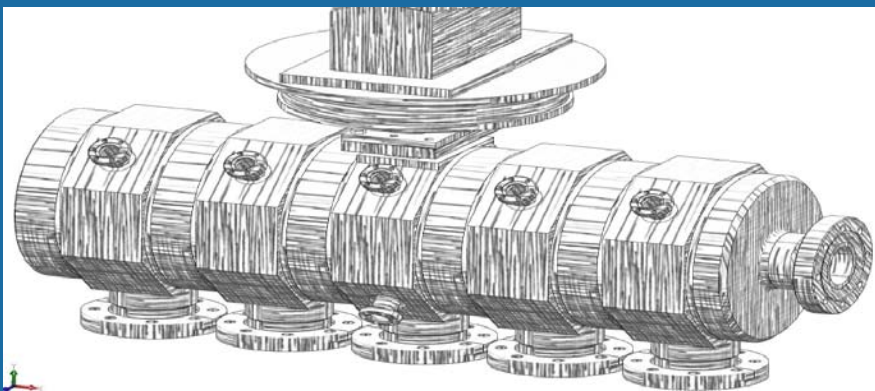
- General Design (needs of the Research Center... dreams of the Physicist !!)
- Global shapes, mandatory dimensions, RF parameters...
- Conditions in use, thermo mechanical requirements, vacuum...





ENGINEERING DESIGN (made by the Industry)

- Precise Design (imperatives of Industry... from dreams to reality)
 - Detailed Design: Mechanics, Cooling systems, Interfaces...
 - Manufacturing Design: Processes choices, Toolings, Fabrication route...



« IDEAL » MATERIALS FOR NC RF CAVITIES

Important « Physical » Properties

	Electrical Conductivity	Thermal Conductivity	Mechanical Stiffness	Secondary Emission Coefficient
- <u>OFHC COPPER</u>	Very Good $5.8 \cdot 10^9 (\Omega.m)^{-1}$	Very Good 400 W/m/K	Poor $1.2 \cdot 10^{10} \text{ daN/m}^2$	Good
- <u>COPPER ON STEEL</u>	Good $5.0 \cdot 10^9 (\Omega.m)^{-1}$	Poor 20 W/m/K	Very Good $2.1 \cdot 10^{10} \text{ daN/m}^2$	Good
- <u>PURE ALUMINUM</u>	Good $3.7 \cdot 10^9 (\Omega.m)^{-1}$	Good 220 W/m/K	Bad $0.7 \cdot 10^{10} \text{ daN/m}^2$	Bad

« IDEAL » MATERIALS FOR NC RF CAVITIES

Important « Engineering » Properties

	Availability Cost	Machinability Formability	Weldability Brazability	Vacuum Outgasing Rate
- <u>OFHC COPPER</u>	Expensive 40 €/Kg	Good	Good	Good $1.5 \cdot 10^{-11}$ mbar.l/s/cm ²
- <u>COPPER ON STEEL</u>	Cheap 4 €/Kg	Good	Very Good	Bad $1.5 \cdot 10^{-10}$ mbar.l/s/cm ²
- <u>PURE ALUMINUM</u>	Rather cheap 10 €/Kg	Good	Bad	Good $1.5 \cdot 10^{-11}$ mbar.l/s/cm ²

FORMING TECHNOLOGIES FOR NC RF CAVITIES

	<u>Cost</u>	<u>Toolings</u>	<u>Accuracy</u>	<u>Surface Quality</u>
MACHINING / ED STRIKING	Cheap	None	High (+/- 2 μ m)	Very Good (<0.1 μ m)
ROLLING / FOLDING	Cheap	Few	Good (+/- 0.5 mm)	Good (<2 μ m)
FORGING / MATRICING	Expensive	Heavy	Rough (+/- 10 mm)	Damaged Crust
SPINNING / FLUOTURNING	Cheap	Shapes	Good (+/- 0.2 mm)	Good (<4 μ m)
DEEP DRAWING / PRESSING	Cheap	Dies	Good (+/- 0.2 mm)	Good (<4 μ m)
HYDROFORMING	Expensive	Multi Dies	Good (+/- 0.2 mm)	Orange Peel
ELECTROFORMING	Expensive	Lost Mould	Good (+/- 0.2 mm)	Etching Pits
EXPLOSING	Cheap	Shapes	Good (+/- 0.2 mm)	Damaged Crust

A combination of several techniques can be used for one given cavity,
according to the concerned part

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MACHINING ED STRIKING



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ROLLING FOLDING

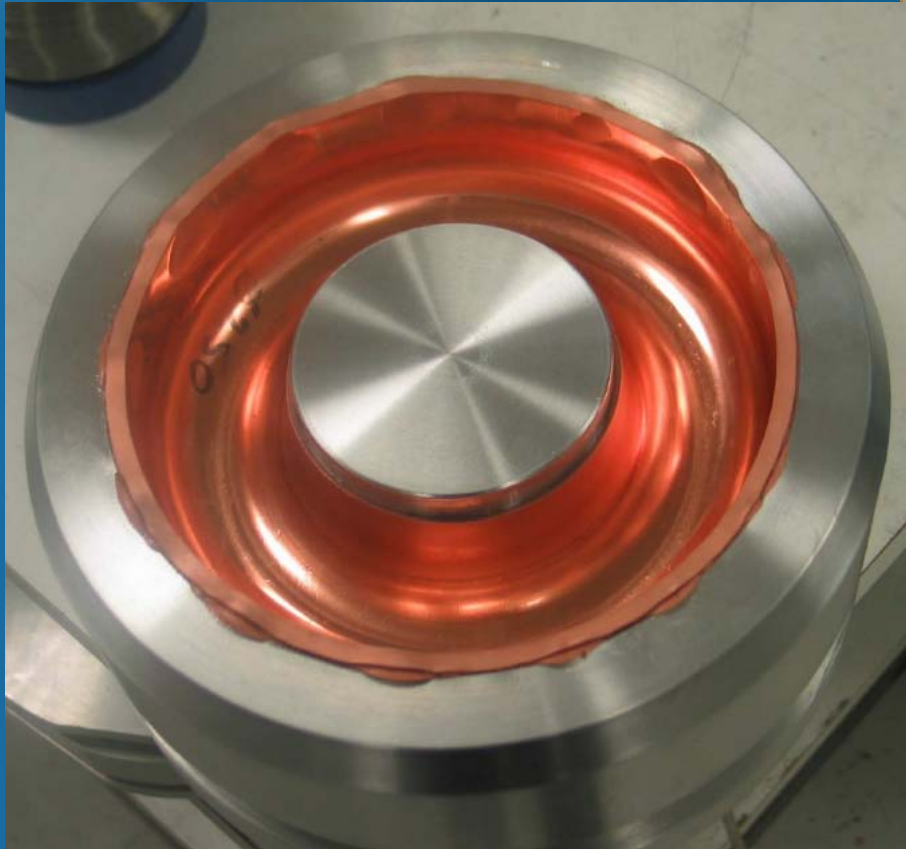


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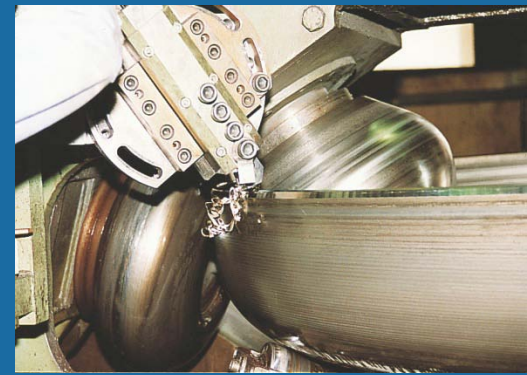
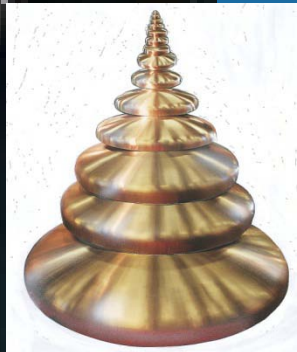
FORGING MATRICING



DEEP DRAWING PRESSING



SPINNING FLUOTURNING



HYDROFORMING

Procédé de mise en forme par HYDROFORMAGE

Etape 1 Mise en place

La pièce à former est serrée par deux mâchoires, et fermée aux extrémités.

Etape 2 Injection d'eau

L'eau sous pression est injectée dans la pièce à former.

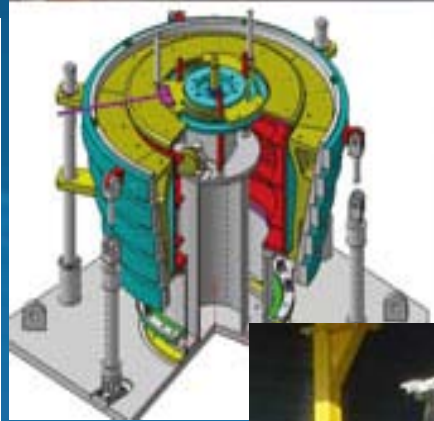
Etape 3 Mise sous pression

La pièce se déforme sous l'action de la pression interne.

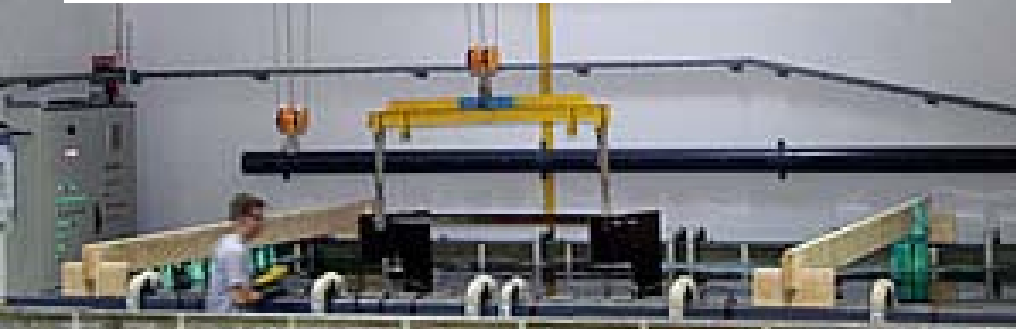
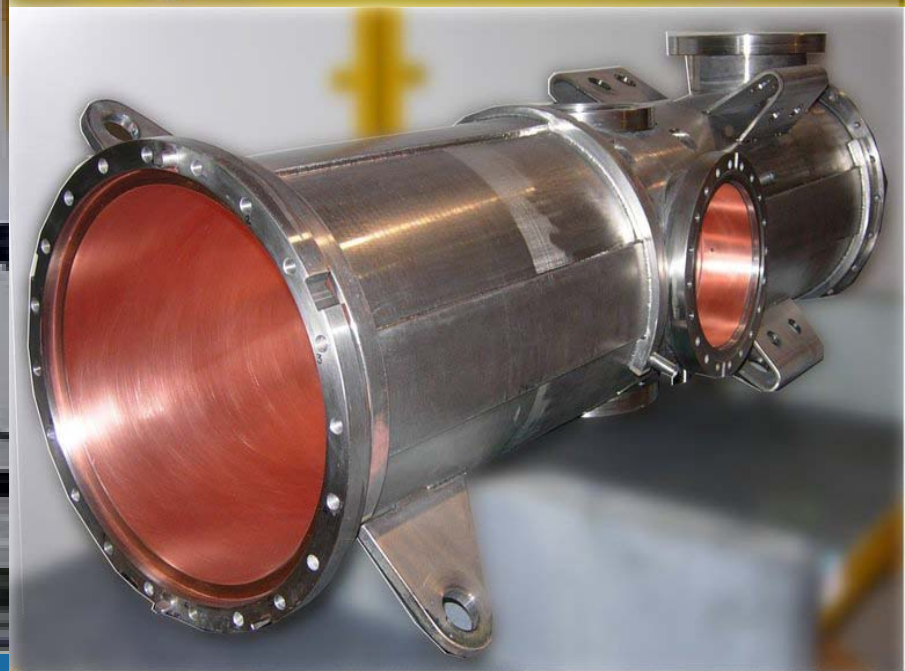
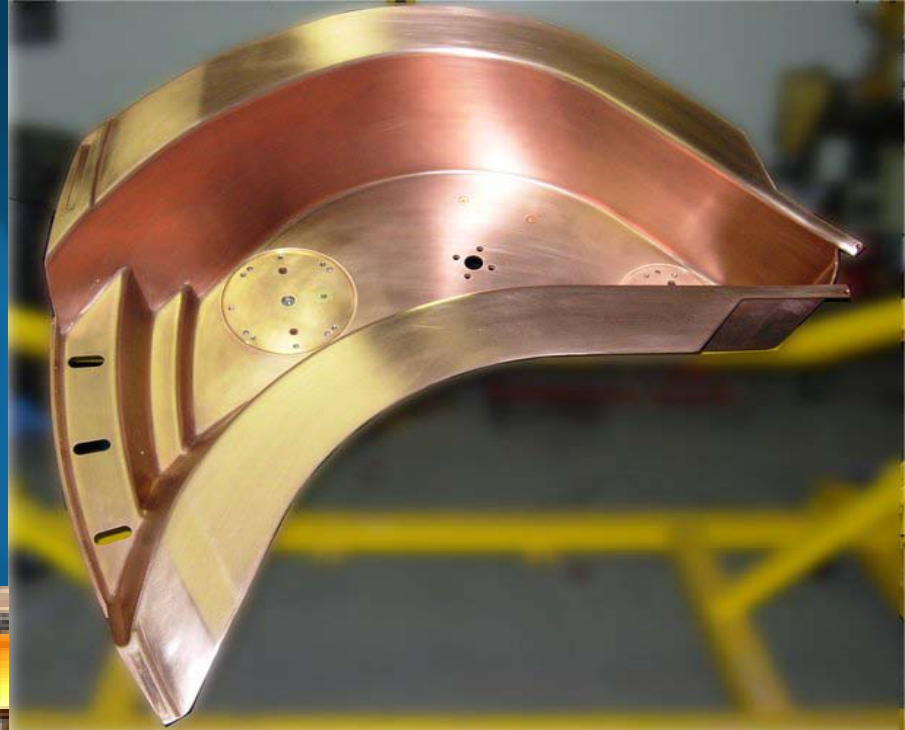
Etape 4 Compression

La pièce est comprimée de l'extérieur pour sa mise en forme finale.

Procédé valable pour mono et multi-couches

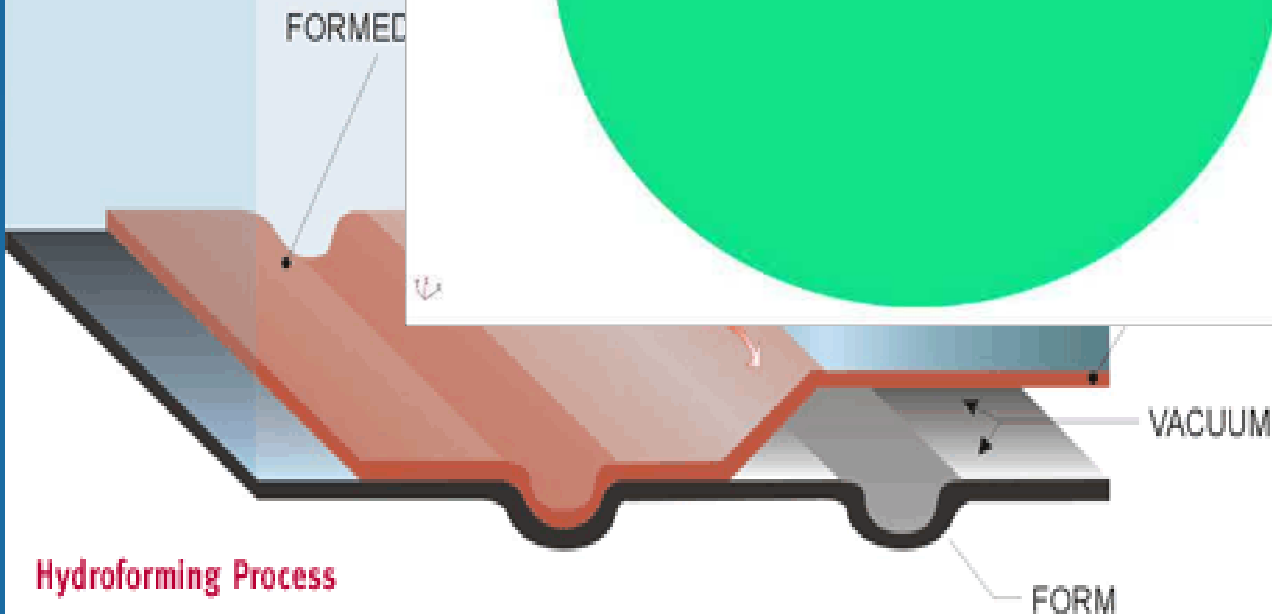


ELECTROFORMING ELECTROPLATING

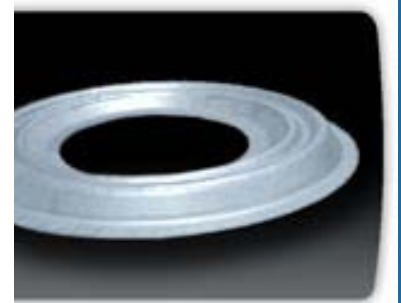




EXPLOS



Hydroforming Process





CLEANING TECHNOLOGIES FOR NC RF CAVITIES

DEGREASING

Hot Solvant Vapours + Alkaline Detergent + US

ETCHING

Acid Desoxydation + Etching (A or B) + Passivation

CHEMICAL POLISHING

Acid + Alcool + Hydrogene Peroxyde Mixture

ELECTROPOLISHING

Acid + Alcool + Current Density

PURE WATER RINSING

ETHANOL DRYING



JOINING TECHNOLOGIES FOR NC RF CAVITIES

VACUUM BRAZING

DIFFUSION BONDING

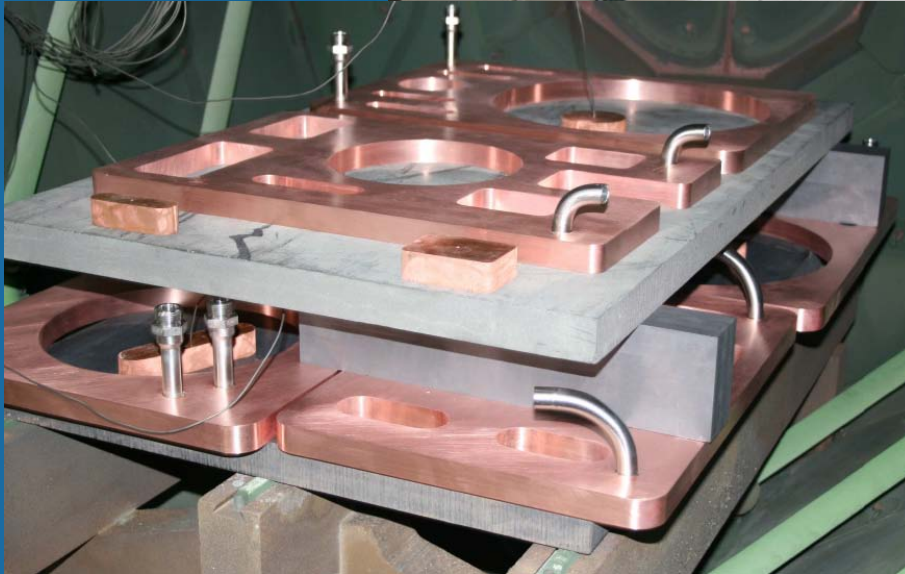
SOLDERING

TIG/MIG WELDING

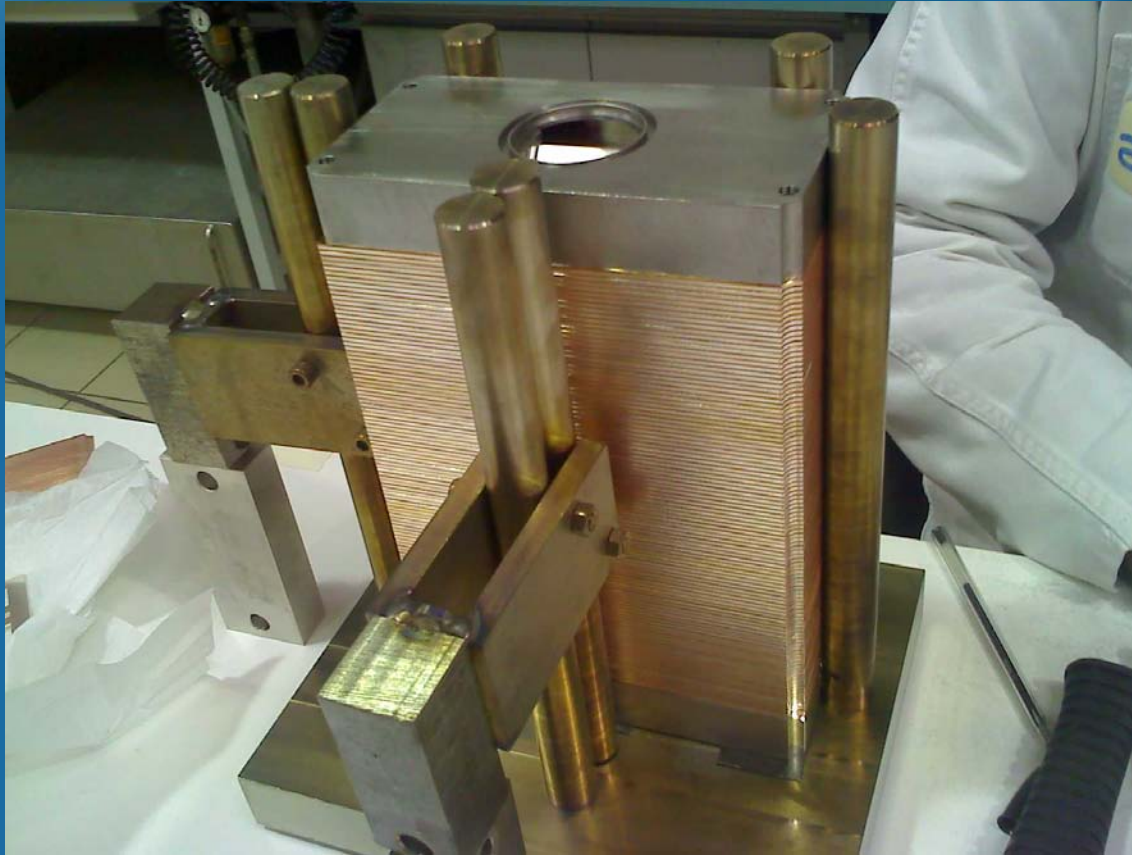
ELECTRON BEAM WELDING



VACUUM BRAZING



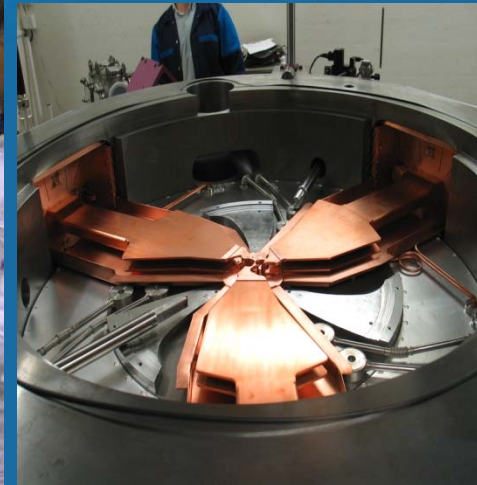
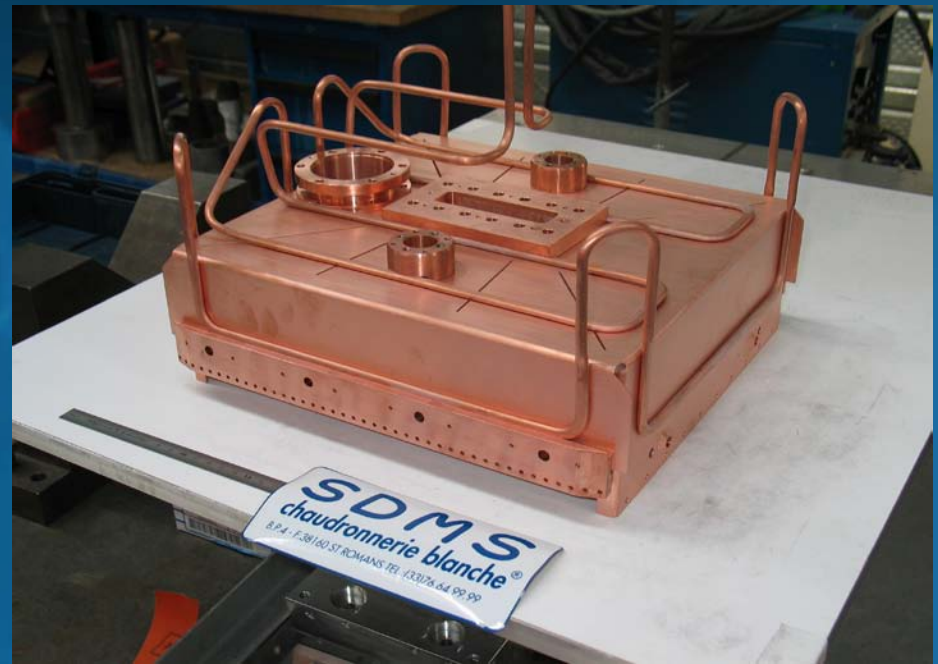
DIFFUSION BONDING



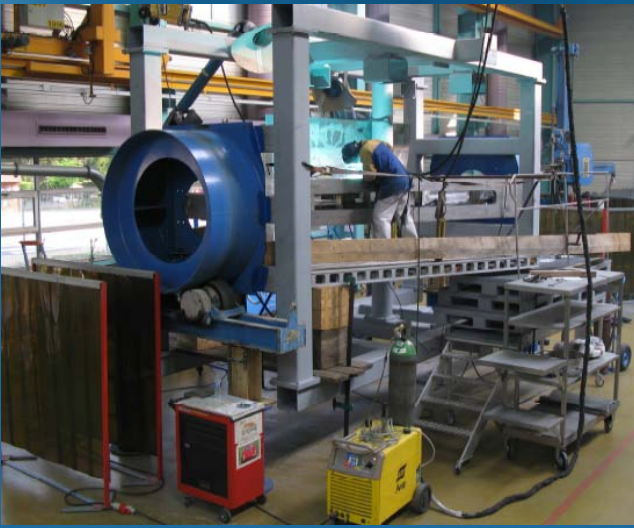
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SOLDERING



TIG/MIG WELDING



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ELECTRON BEAM WELDING



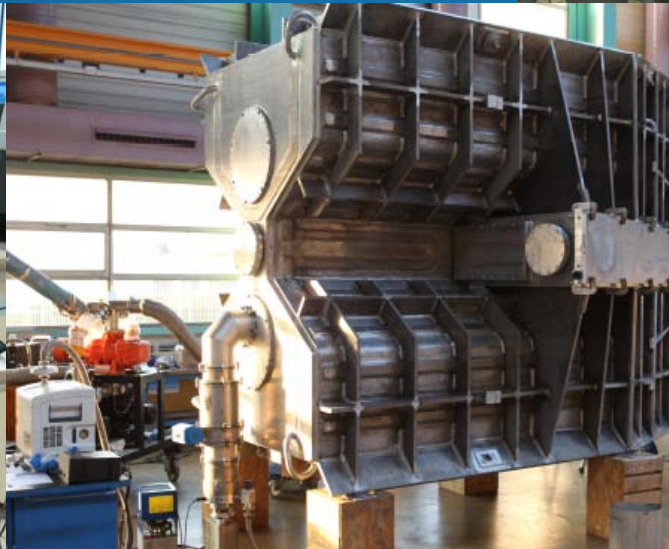
ND TESTING TECHNOLOGIES FOR NC RF CAVITIES

3D CONTROLS

HELIUM LEAK TESTS

RF TESTS AND ADJUSTMENTS

VACUUM CONDITIONNING



PSI 56 MHz pure Al Cavity
Al TIG, MIG, and EB Welded

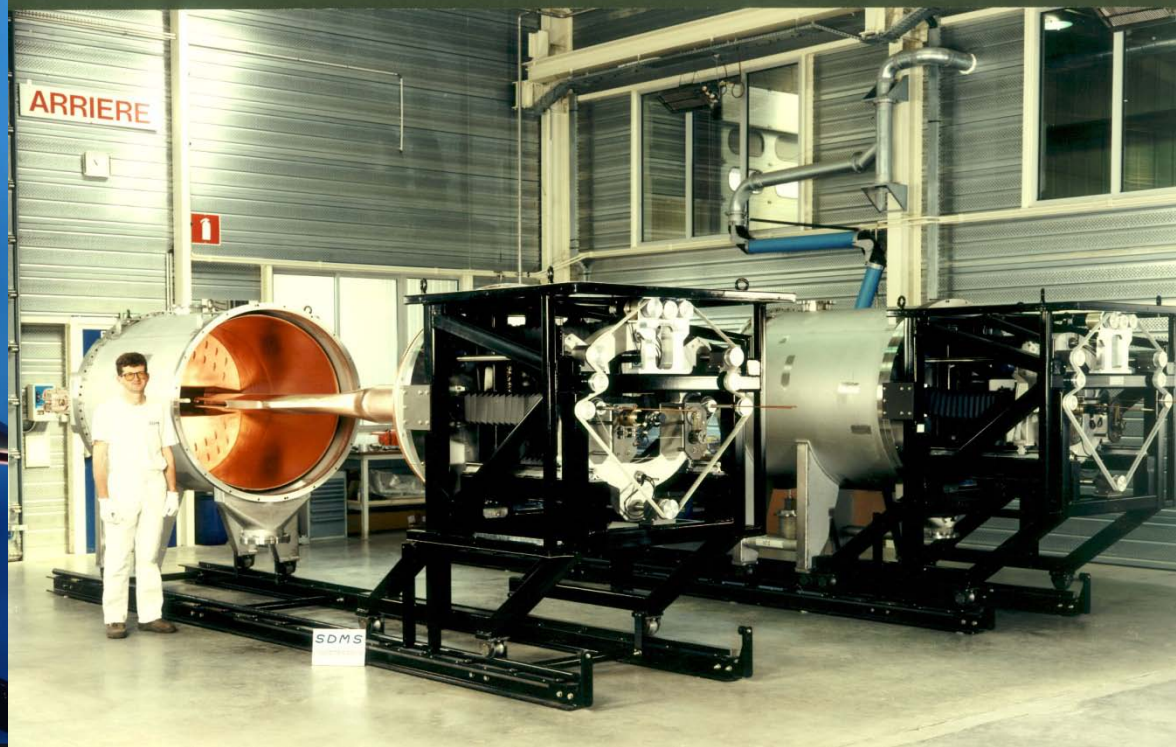
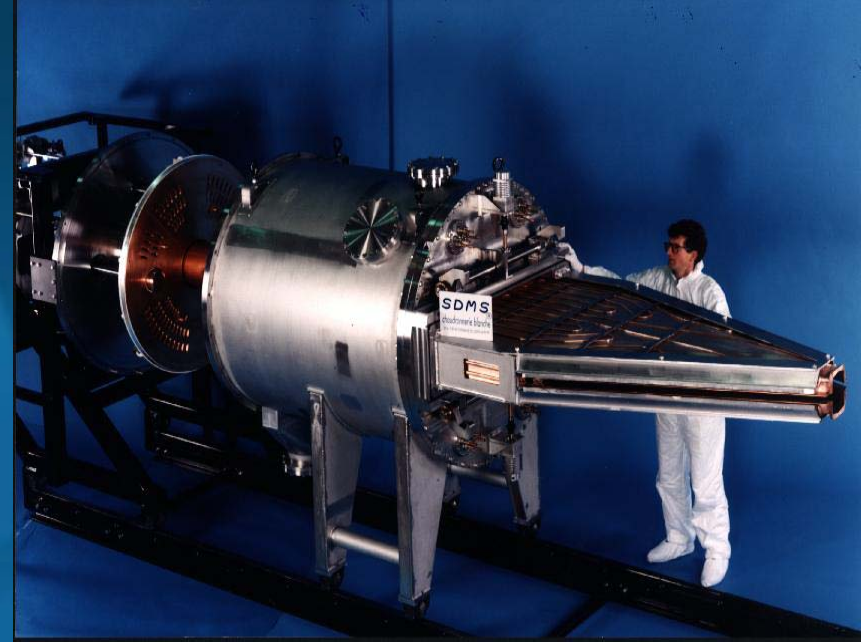


PSI 65 MHz pure Cu Cavity
Cu TIG and EB Welded
SS/Cu Brazed and Soldered

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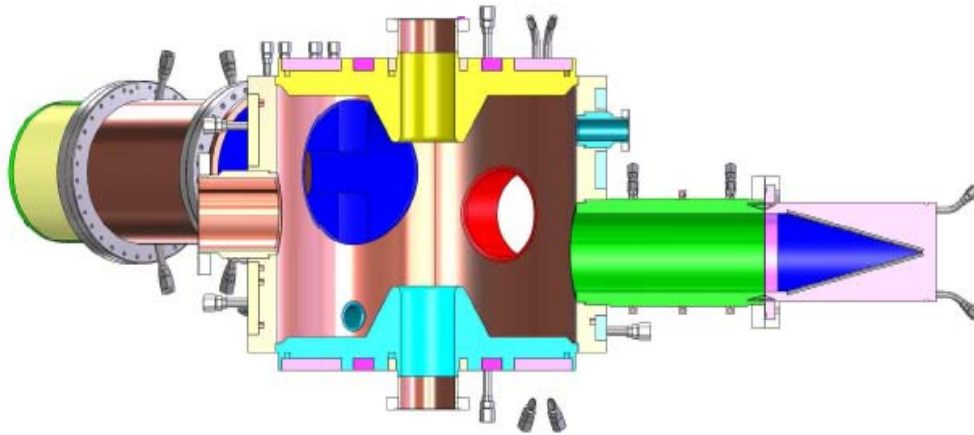
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GANIL 9 to 15 MHz Cu and SS CAVITIES
Cu EB Welded and Brazed
SS TIG Welded
Cu Plated on SS

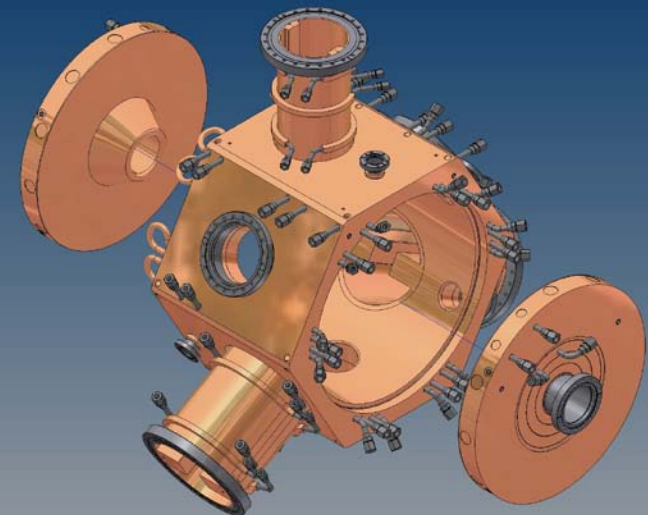


THE NEW ESRF Cu CAVITY: RF Design by the Lab

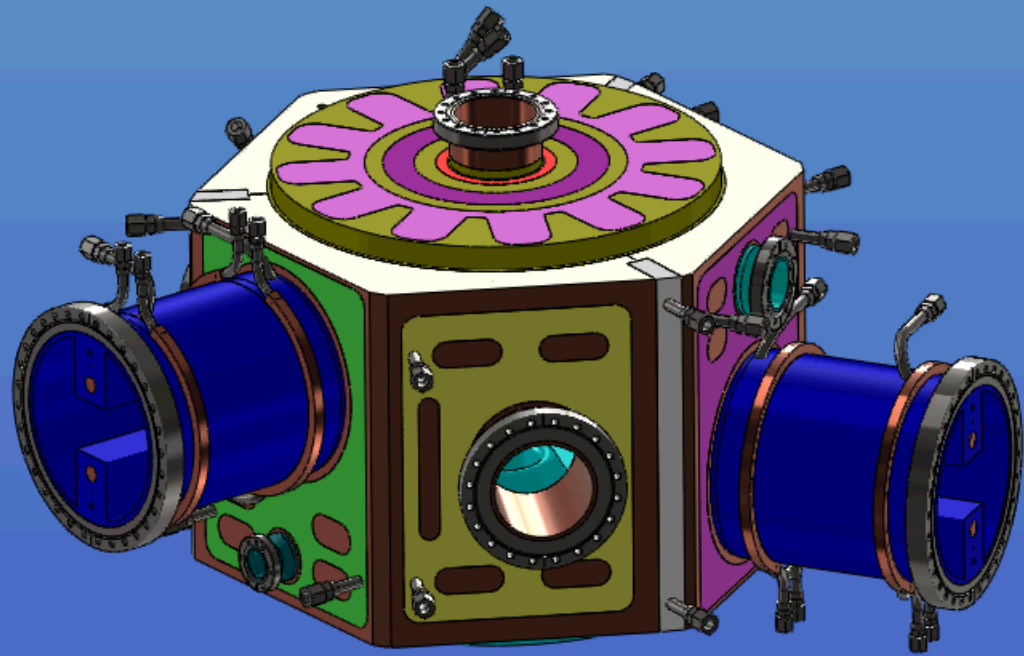
A NICE COMPARISON OF 2 MANUFACTURING ROUTES
A FAIR COMPETITION BETWEEN 2 SKILLED SUPPLIERS



EB Welded Concept (SDMS)



Vacuum Brazed Concept (RI)





Thanks to SDMS Industrial partners for photos credit:

**BONITEMPO (Spinning), COURBIS (Deep Drawing), CORIMA (Electroforming),
BRILLAT (Rolling), OMG (Machining), HYDROPRESS (Hydroforming), CARLIER
(Forging), EXPLOFORM (Explosing)**

THANK YOU FOR YOUR KIND ATTENTION...!